

Features

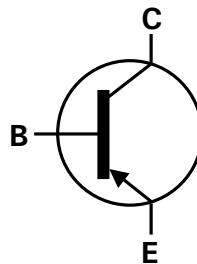
- $BV_{CEO} > -120V$
- Max Continuous Current $I_C = -0.8A$
- High Gain Holds up $h_{FE} \geq 120$ @ $I_C = -100mA$
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

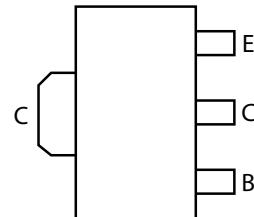
- Case: SOT89
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.05 grams (Approximate)



Top View



Device Symbol


 Top View
 Pin Out

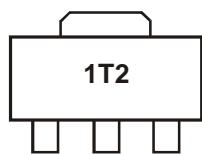
Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
2DA1201Y-7	AEC-Q101	1T2	7	12	1,000
2DA1201YQTC	Automotive	1T2	13	12	4,000

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.
5. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



1T2 = Product Type Marking Code

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-120	V
Collector-Emitter Voltage	V_{CEO}	-120	V
Emitter-Base Voltage	V_{EBO}	-7	V
Continuous Collector Current	I_C	-800	mA
Peak Pulse Current (Note 6)	I_{CM}	-3	A
Base Current	I_B	-160	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P_D	1.5	W
Thermal Resistance, Junction to Ambient (Note 7)	$R_{\theta JA}$	83	°C/W
Thermal Resistance, Junction to Leads (Note 8)	$R_{\theta JL}$	18.3	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

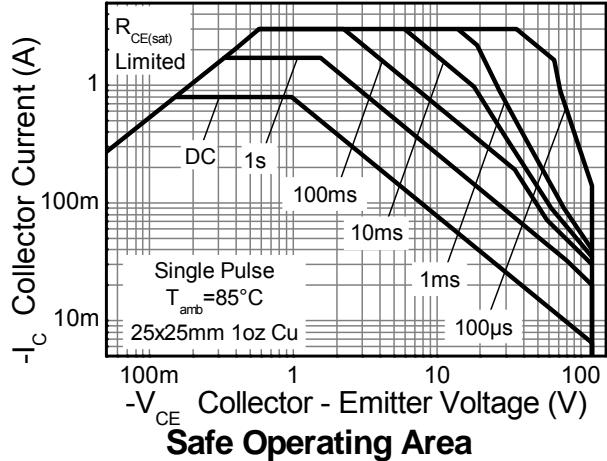
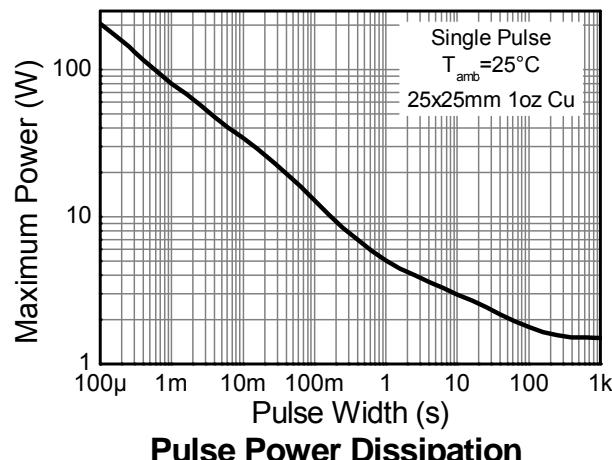
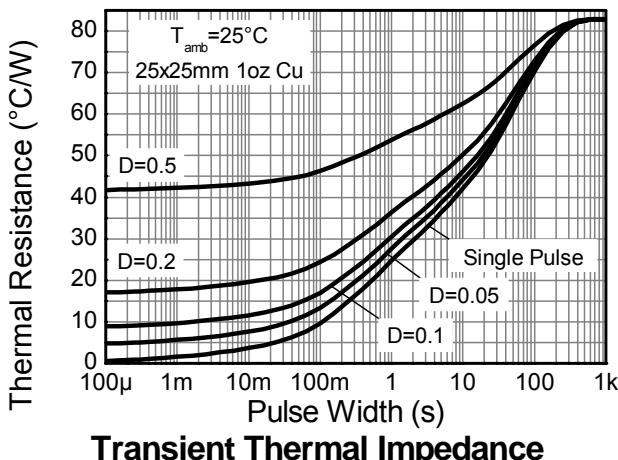
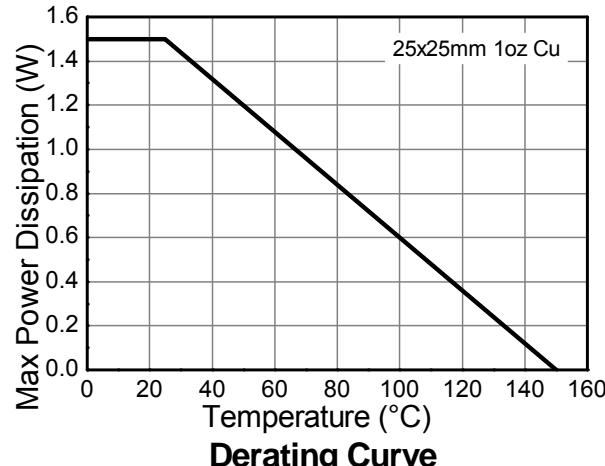
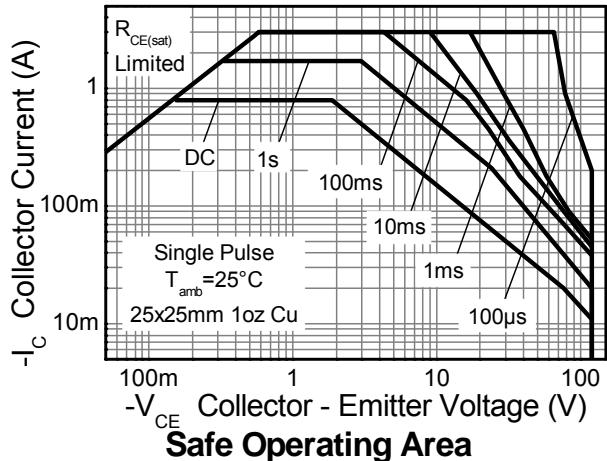
ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	$\geq 8,000$	V	3B
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	C

Notes:

6. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.
7. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions.
8. Thermal resistance from junction to solder-point (at the end of the collector lead).
9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information

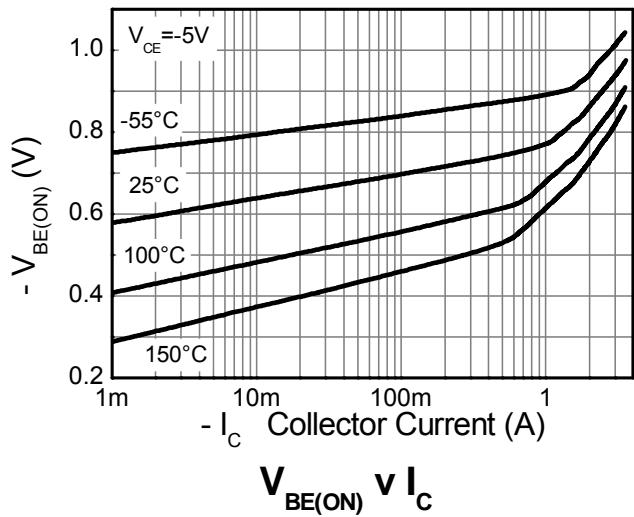
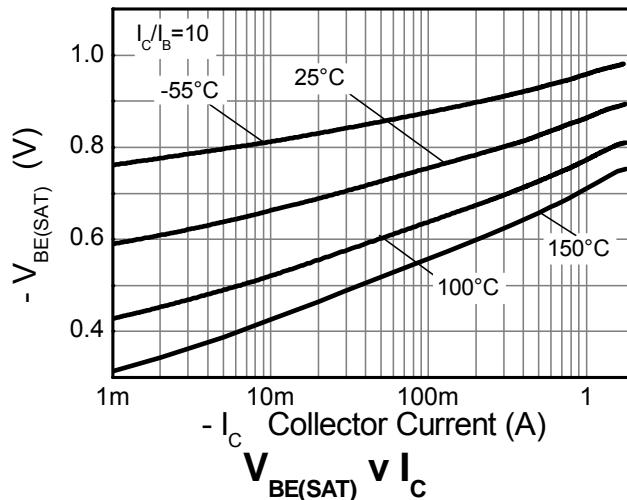
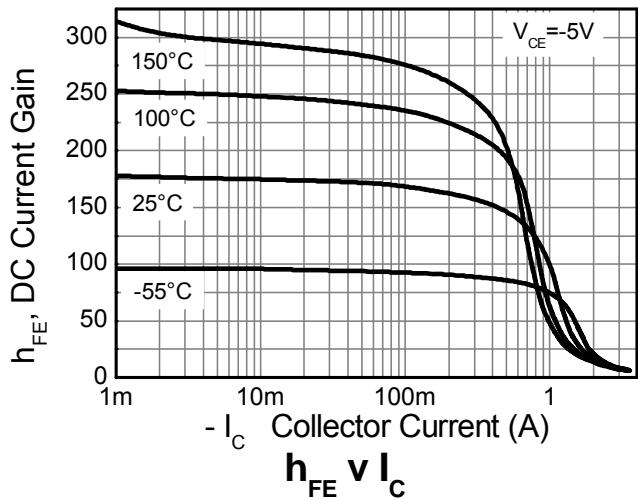
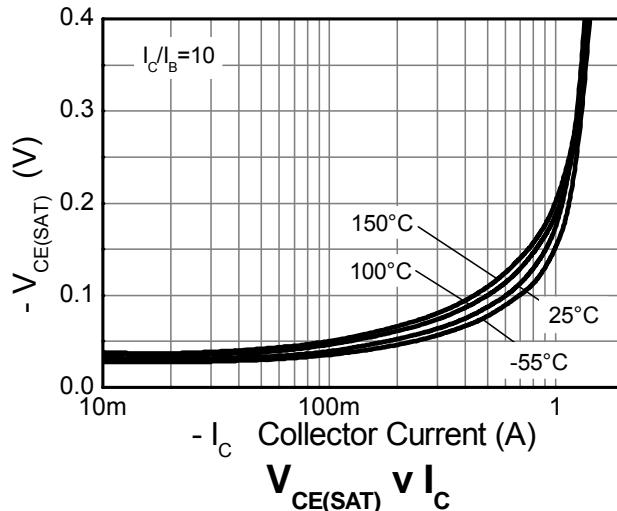
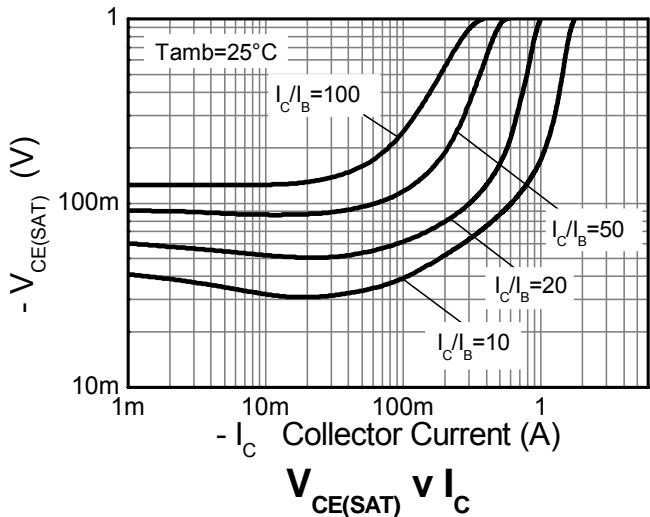


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-120	-	-	V	I _C = -100µA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-120	-	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-	-	V	I _E = -100µA
Collector-Emitter Cut-off Current	I _{CES}	-	-	-100	nA	V _{CE} = -120V
Collector Cut-off Current	I _{CBO}	-	-	-100	nA	V _{CB} = -120V
Emitter Cut-off Current	I _{EBO}	-	-	-100	nA	V _{EB} = -5V
Static Forward Current Transfer Ratio (Note 10)	h _{FE}	120	-	240	-	I _C = -100mA, V _{CE} = -5V
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(sat)}	-	-	-1	V	I _C = -500mA, I _B = -50mA
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(on)}	-	-	-1	V	I _C = -500mA, V _{CE} = -5V
Transition Frequency	f _T	-	160	-	MHz	I _C = -100mA, V _{CE} = -5V
Output Capacitance	C _{BO}		15		pF	V _{CB} = -10V, I _E = 0, f = 1MHz
Delay Time	t _(d)	-	62	-	ns	
Rise Time	t _(r)	-	50	-	ns	
Storage Time	t _(s)	-	440	-	ns	
Fall Time	t _(f)	-	42	-	ns	

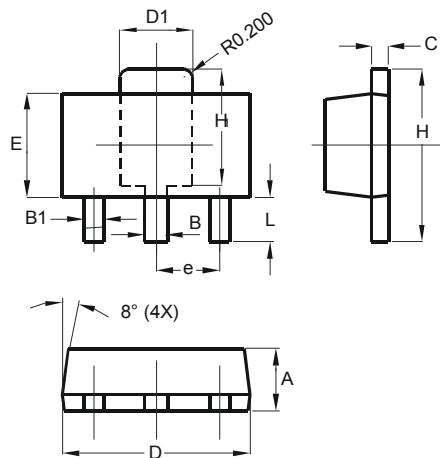
Note: 10. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

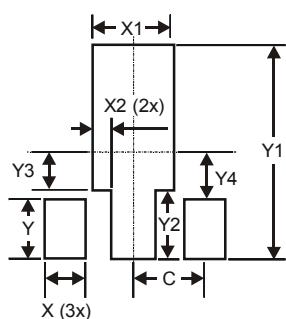


SOT89		
Dim	Min	Max
A	1.40	1.60
B	0.44	0.62
B1	0.35	0.54
C	0.35	0.44
D	4.40	4.60
D1	1.62	1.83
E	2.29	2.60
e	1.50 Typ	
H	3.94	4.25
H1	2.63	2.93
L	0.89	1.20

All Dimensions in mm

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
C	1.500

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